



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max T _A = +25°C |
|-------------------|-----------------------------|--|
| 60V | 7.5Ω @ V _{GS} = 5V | 0.23A |

This MOSFET is designed to meet the stringent requirements of

automotive applications. It is qualified to AEC-Q101, supported by a

Features and Benefits

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 2N7002DWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Lead-Frame (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (e3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)





Ordering Information (Note 4)

Description and Applications

Power Management Functions

PPAP, and is ideal for use in:

Motor Control

| Part Number | Case | Packaging |
|----------------|--------|--------------------|
| 2N7002DWQ-7-F | SOT363 | 3,000/Tape & Reel |
| 2N7002DWQ-13-F | SOT363 | 10,000/Tape & Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

| \square | | |
|-----------|-----|--|
| K72 | ΥM | |
| MY | K72 | |
| | | |

K72 = Product Type Marking Code YM = Date Code Marking

Top View Internal Schematic

Y or \overline{Y} = Year (ex: I = 2021)

M = Month (ex: 9 = September)

Date Code Key

| Year | 1998 | | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 |
|-------|------|-----|------|------|------|------|------|------|------|------|------|------|
| Code | J | | | J | K | L | М | Ν | 0 | Р | R | S |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|--|-----------------|---|------------------|----------------------|---|
| Drain-Source Voltage | | V _{DSS} | 60 | V | |
| Prain-Gate Voltage R_{GS} ≤ 1.0MΩ | | | V _{DGR} | 60 | V |
| | Co | ntinuous | V _{GSS} | ±20 | V |
| Gate-Source Voltage | | Pulsed | V _{GSS} | ±40 | V |
| Continuous Drain Current (Note 6) V_{GS} = 5V | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ $T_A = +100^{\circ}C$ | ID | 0.23 0.18 0.14 | A |
| Maximum Continuous Body Diode Forward Current (Note 6) | | | Is | 0.23 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | 0.8 | A |

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

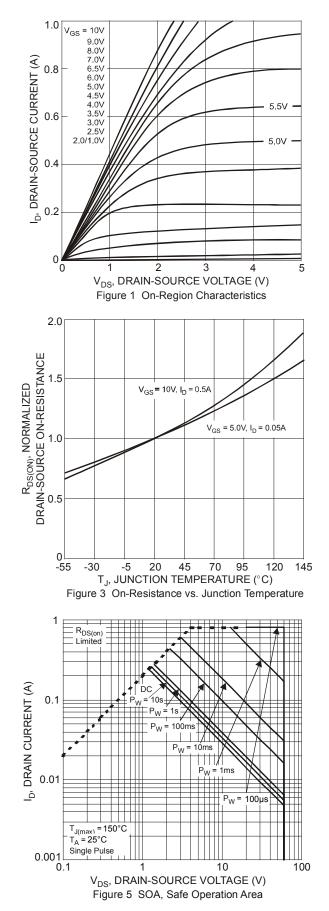
| Characteristic | | Symbol | Value | Unit |
|--|-------------------------|----------------------------------|-------------|------|
| | T _A = +25°C | | 0.31 | |
| Total Power Dissipation (Note 5) | T _A = +70°C | PD | 0.2 | W |
| | T _A = +100°C | | 0.12 | |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{	hetaJA}$ | 410 | °C/W |
| | T _A = +25°C | | 0.4 | |
| Total Power Dissipation (Note 6) | T _A = +70°C | PD | 0.25 | W |
| | T _A = +100°C | | 0.15 | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $R_{	hetaJA}$ | 318 | °C/W |
| Thermal Resistance, Junction to Case (Note 6) | Steady State | $R_{	ext{	heta}JC}$ | 135 | °C/W |
| Operating and Storage Temperature Range | | T _{J,} T _{STG} | -55 to +150 | °C |

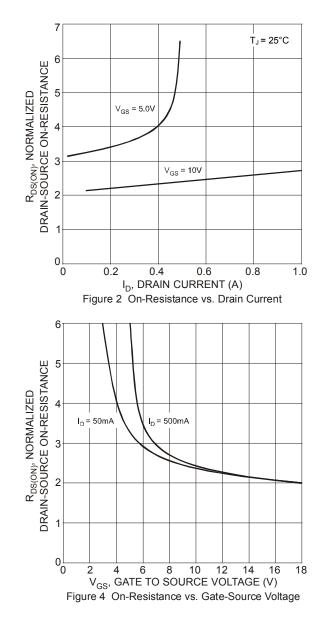
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Min | Тур | Max | Unit | Test Condition |
|-----------------------------------|---|---------------------|-----|------------|------------|------|--|
| OFF CHARACTERISTICS (Note 7) | | | | | - | - | |
| Drain-Source Breakdown Voltage | | BV _{DSS} | 60 | 70 | | V | V_{GS} = 0V, I_{D} = 10 μ A |
| Zero Gate Voltage Drain Current | @ T _C = +25°C @ T _C = +125°C | I _{DSS} | _ | _ | 1.0 500 | μA | V _{DS} = 60V, V _{GS} = 0V |
| Gate-Body Leakage | | IGSS | | | ±10 | nA | V_{GS} = ±20V, V_{DS} = 0V |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | | V _{GS(TH)} | 1.0 | | 2.0 | V | V_{DS} = V_{GS} , I_D = 250 μ A |
| Static Drain-Source On-Resistance | @ T _J = +25°C | D | _ | 3.2 4.4 | 7.5 | Ω | V _{GS} = 5.0V, I _D = 0.05A |
| | @ T _J = +125°C | R _{DS(ON)} | | | 13.5 | | V _{GS} = 10V, I _D = 0.5A |
| On-State Drain Current | | I _{D(ON)} | 0.5 | 1.0 | | А | V _{GS} = 10V, V _{DS} = 7.5V |
| Forward Transconductance | | g fs | 80 | | | mS | V _{DS} = 10V, I _D = 0.2A |
| Diode Forward Voltage | | V _{SD} | | 0.78 | 1.5 | V | V _{GS} = 0V, I _S = 115mA |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | | Ciss | | 22 | 50 | рF | |
| Output Capacitance | | Coss | | 11 | 25 | pF | $V_{DS} = 25V, V_{GS} = 0V$ |
| Reverse Transfer Capacitance | | Crss | _ | 2.0 | 5.0 | рF | f = 1.0MHz |
| Turn-On Delay Time | | t _{D(ON)} | _ | 7.0 | 20 | | V _{DD} = 30V, I _D = 0.2A, |
| Turn-Off Delay Time | | t _{D(OFF)} | | 11.0 | 20 | ns | R _L = 150Ω, V _{GEN} = 10V, R _{GEN} = 25Ω |

 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing. Notes:



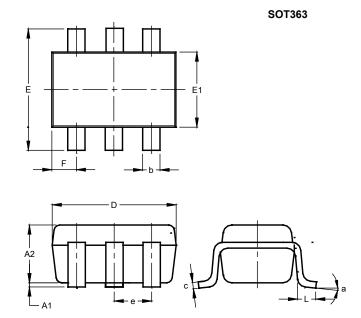






Package Outline Dimensions

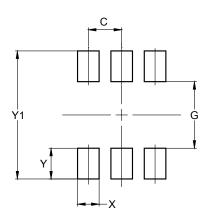
Please see http://www.diodes.com/package-outlines.html for the latest version.



| | | T262 | | | | | | | | |
|-------|--------|--------|-------|--|--|--|--|--|--|--|
| | SOT363 | | | | | | | | | |
| Dim | Min | Max | Тур | | | | | | | |
| A1 | 0.00 | 0.10 | 0.05 | | | | | | | |
| A2 | 0.90 | 1.00 | 0.95 | | | | | | | |
| b | 0.10 | 0.30 | 0.25 | | | | | | | |
| С | 0.10 | 0.22 | 0.11 | | | | | | | |
| D | 1.80 | 2.20 | 2.15 | | | | | | | |
| Е | 2.00 | 2.20 | 2.10 | | | | | | | |
| E1 | 1.15 | 1.35 | 1.30 | | | | | | | |
| е | C | .650 E | SC | | | | | | | |
| F | 0.40 | 0.45 | 0.425 | | | | | | | |
| L | 0.25 | 0.40 | 0.30 | | | | | | | |
| а | 0° | 8° | | | | | | | | |
| All I | Dimen | sions | in mm | | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value |
|------------|---------|
| | (in mm) |
| С | 0.650 |
| G | 1.300 |
| Х | 0.420 |
| Y | 0.600 |
| Y1 | 2.500 |

SOT363



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